

Z21 ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per Table 1

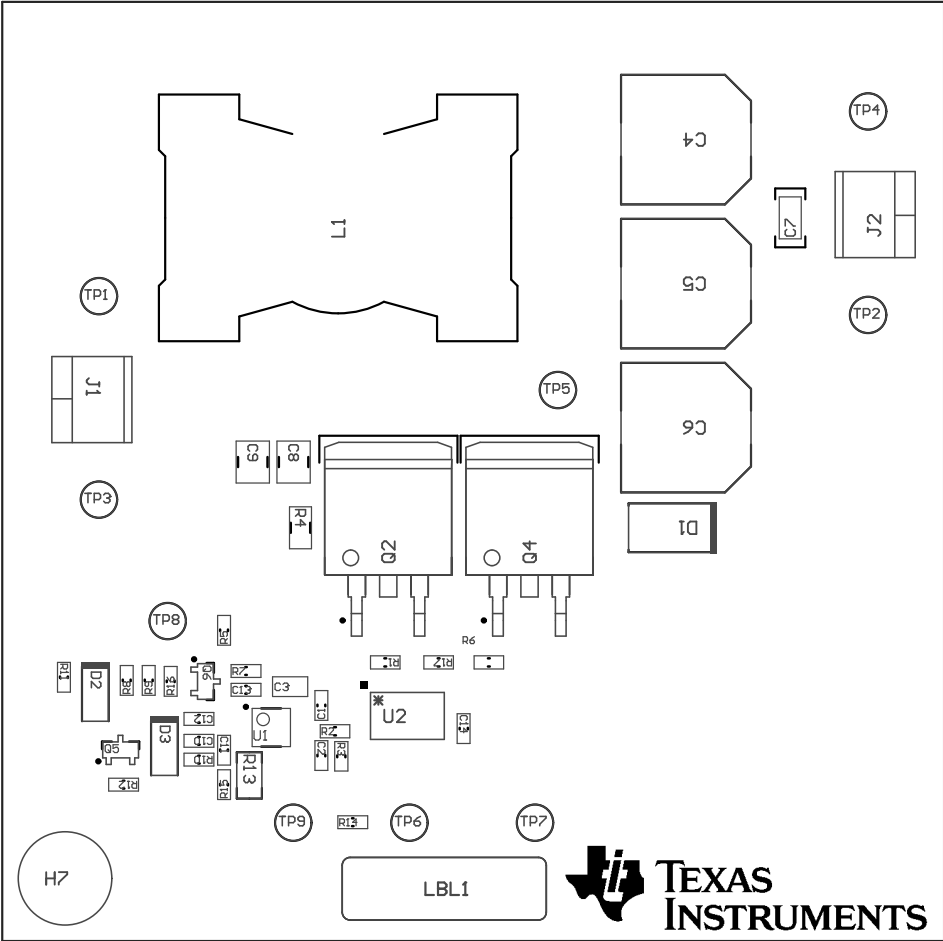
Z22 ■These assemblies are ESD sensitive, ESD precautions shall be observed.

Z23 ■These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Z24 ■These assemblies must comply with workmanship standards IPC-A-610 Class 3, unless otherwise specified.

H3

H4



H7

TABLE 1	
Variant	Label text
001	ChangeMe!
002	ChangeMe!

H8

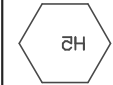
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS

ASSEMBLY VARIANT: 001

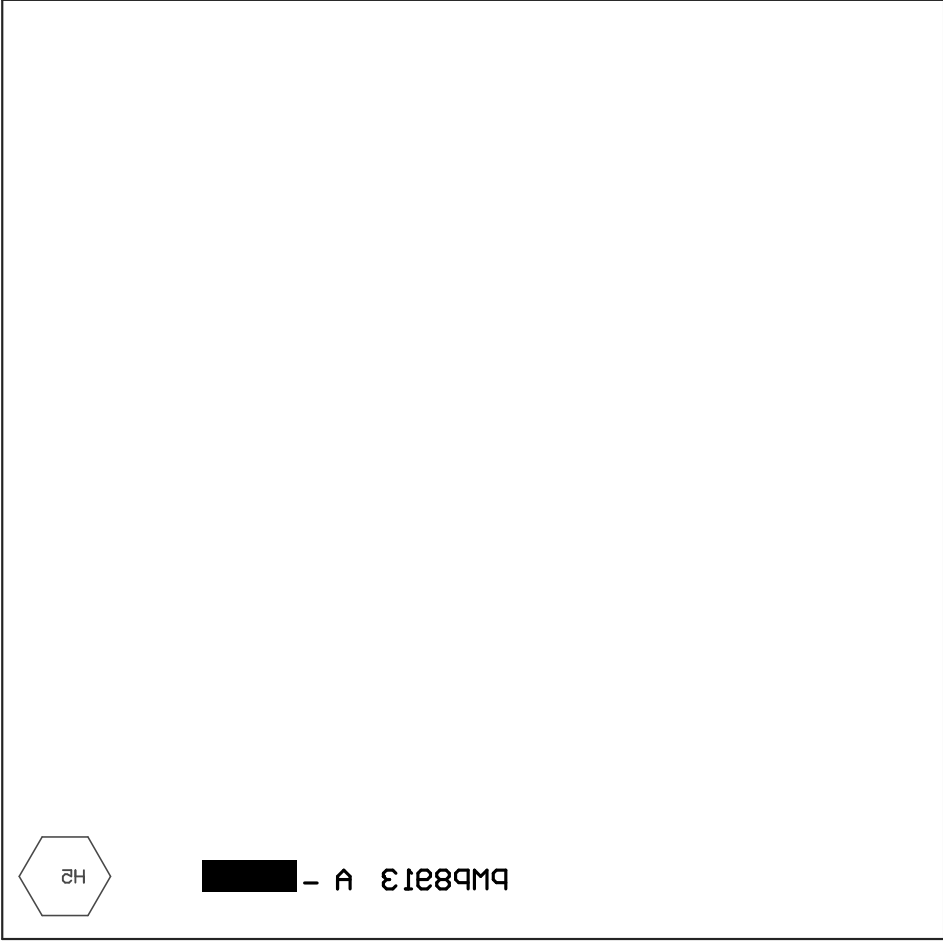
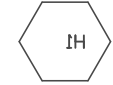
PCB VIEWED FROM TOP SIDE	BOARD #: PMP8913	REV: A	SUN REV: Not In VersionControl
IGNORE -> Top Overlay			
PLOT NAME = Top Assembly Drawing	GENERATED : 2/15/2013 1:55:33 PM	TEXAS INSTRUMENTS	

PLOT NAME = Bottom Assembly Drawing		GENERATED : 2\12\2013 1:55:33 PM	TEXAS INSTRUMENTS
		IGNORE -> Bottom Overlay	
PCB VIEWED FROM BOTTOM SIDE		BOARD #: PMP8913	REV: A
		JUN REV: Not In VersionControl	

ASSEMBLY VARIANT: 001  
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS



PMP8913 A - [REDACTED]



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